

December 9, 2022

IGI Report Number

Shape and Cutting Style

ADDITIONAL GRADING INFORMATION

Comments: As Grown - No indication of post-growth

This Laboratory Grown Diamond was created by High

Pressure High Temperature (HPHT) growth process.

Description

Measurements

Carat Weight

Color Grade

Clarity Grade

Polish

Symmetry

Fluorescence

Inscription(s)

treatment.

Type II

GRADING RESULTS

**ELECTRONIC COPY** 

LABORATORY GROWN DIAMOND REPORT

# LABORATORY GROWN DIAMOND REPORT

LG559282122 Report verification at igi.org

#### LABORATORY GROWN DIAMOND REPORT

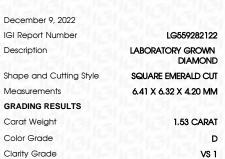
# **GRADING SCALES**

### CLARITY

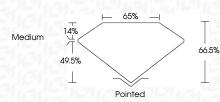
IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	l <sup>1-3</sup>
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

#### COLOR

DEFGHIJ Faint Very Light Light	D	Е	F	G	Н	1	J	Faint	Very Light	Light
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LABORATORY GROWN DIAMOND REPORT



Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	LABGROWN (67) LG559282122
Comments: As Grov treatment.	vn - No indication of post-growth

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

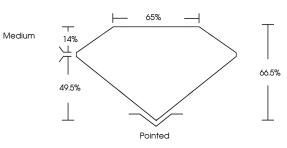
edium	14% 14% 49.5%	<u>⊢ 65% ⊣</u>	>   66.5
		Pointed	

# ADDITIONAL GRADING INFORMATION

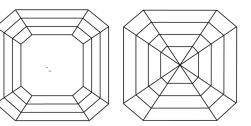




PROPORTIONS



#### **CLARITY CHARACTERISTICS**



Red symbols indicate internal characteristics. Green symbols indicate external characteristics.

**KEY TO SYMBOLS** 

LABGROWN (13) LG559282122

LG559282122

DIAMOND

1.53 CARAT

**EXCELLENT EXCELLENT** 

NONE

D

**VS** 1

LABORATORY GROWN

SQUARE EMERALD CUT

6.41 X 6.32 X 4.20 MM





LASERSCRIBE

Sample Image Used





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